# **General Purpose Transistor**

# **PNP Silicon**

# Features

- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V <sub>CEO</sub>	-40	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	-40	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	-200	mAdc
Collector Current – Peak (Note 3)	I <sub>CM</sub>	-800	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1) @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\thetaJA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\thetaJA}$	417	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.

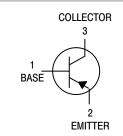
2. Alumina = 0.4  $\times$  0.3  $\times$  0.024 in. 99.5% alumina.

3. Reference SOA curve.



# **ON Semiconductor®**

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SOT-23 (TO-236) CASE 318 STYLE 6

### MARKING DIAGRAM



2A = Specific Device Code

#### M = Date Code\*

= Pb–Free Package

(Note: Microdot may be in either location) \*Date Code orientation and/or overbar may

vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>			
MMBT3906LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel			
MMBT3906LT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel			
SMMBT3906LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel			
SMMBT3906LT3G	SOT–23 (Pb–Free)	10,000 / Tape & Reel			

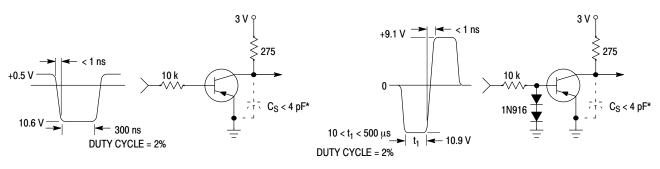
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Charac	teristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage $(I_C = -1.0 \text{ mAdc}, I_B = 0)$		V <sub>(BR)CEO</sub>	-40	-	Vdc
Collector–Base Breakdown Voltage $(I_C = -10 \ \mu Adc, I_E = 0)$		V <sub>(BR)CBO</sub>	-40	_	Vdc
Emitter – Base Breakdown Voltage $(I_E = -10 \ \mu Adc, I_C = 0)$		V <sub>(BR)EBO</sub>	-5.0	-	Vdc
Base Cutoff Current (V <sub>CE</sub> = -30 Vdc, V <sub>EB</sub> = -3.0 Vdc)		I <sub>BL</sub>	_	-50	nAdc
Collector Cutoff Current (V <sub>CE</sub> = -30 Vdc, V <sub>EB</sub> = -3.0 Vdc)		ICEX	_	-50	nAdc
ON CHARACTERISTICS (Note 4)					
$ \begin{array}{l} \text{DC Current Gain} \\ (I_C = -0.1 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc} \\ (I_C = -1.0 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc} \\ (I_C = -10 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc} ) \\ (I_C = -50 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc} ) \\ (I_C = -100 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc} ) \end{array} $	)	H <sub>FE</sub>	60 80 100 60 30	_  300  _	_
Collector – Emitter Saturation Voltage ( $I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc}$ ) ( $I_C = -50 \text{ mAdc}, I_B = -5.0 \text{ mAdc}$ )		V <sub>CE(sat)</sub>		-0.25 -0.4	Vdc
$\begin{array}{l} \text{Base-Emitter Saturation Voltage} \\ (I_C = -10 \text{ mAdc}, \text{ I}_B = -1.0 \text{ mAdc}) \\ (I_C = -50 \text{ mAdc}, \text{ I}_B = -5.0 \text{ mAdc}) \end{array}$		V <sub>BE(sat)</sub>	-0.65 -	-0.85 -0.95	Vdc
SMALL-SIGNAL CHARACTERISTICS					
$\label{eq:current-Gain-Bandwidth Product} \begin{split} Current-Gain-Bandwidth Product \\ (I_C = -10 \text{ mAdc}, \text{ V}_{CE} = -20 \text{ Vdc},  \end{split}$	f = 100 MHz)	f <sub>T</sub>	250	-	MHz
Output Capacitance $(V_{CB} = -5.0 \text{ Vdc}, I_E = 0, f = 1.0 \text{ M})$	Hz)	C <sub>obo</sub>	_	4.5	pF
Input Capacitance (V <sub>EB</sub> = $-0.5$ Vdc, I <sub>C</sub> = 0, f = 1.0 M	Hz)	C <sub>ibo</sub>	_	10	pF
Input Impedance $(I_{C} = -1.0 \text{ mAdc}, V_{CE} = -10 \text{ Vdc}, f = 1.0 \text{ kHz})$		h <sub>ie</sub>	2.0	12	kΩ
Voltage Feedback Ratio (I <sub>C</sub> = -1.0 mAdc, V <sub>CE</sub> = -10 Vdc, f = 1.0 kHz)		h <sub>re</sub>	0.1	10	X 10 <sup>-4</sup>
Small-Signal Current Gain ( $I_C = -1.0 \text{ mAdc}$ , $V_{CE} = -10 \text{ Vdc}$ , f = 1.0 kHz)		h <sub>fe</sub>	100	400	_
Output Admittance ( $I_C = -1.0 \text{ mAdc}$ , $V_{CE} = -10 \text{ Vdc}$ , f = 1.0 kHz)		h <sub>oe</sub>	3.0	60	μmhos
Noise Figure (I <sub>C</sub> = -100 $\mu$ Adc, V <sub>CE</sub> = -5.0 Vdc, R <sub>S</sub> = 1.0 kΩ, f = 1.0 kHz)		NF	_	4.0	dB
SWITCHING CHARACTERISTICS					
Delay Time	$(V_{CC} = -3.0 \text{ Vdc}, V_{BE} = 0.5 \text{ Vdc},$	t <sub>d</sub>	-	35	

Delay Time		$(V_{CC} = -3.0 \text{ Vdc}, V_{BE} = 0.5 \text{ Vdc}, \\ I_C = -10 \text{ mAdc}, I_{B1} = -1.0 \text{ mAdc})$	t <sub>d</sub>	-	35	00	
Rise Time			tr	-	35	ns	
Storage Tim	e	$(V_{CC} = -3.0 \text{ Vdc}, I_C = -10 \text{ mAdc}, I_{B1} = I_{B2} = -1.0 \text{ mAdc})$	t <sub>s</sub>	-	225	ns	Ī
Fall Time			t <sub>f</sub>	-	75	115	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2.0%.

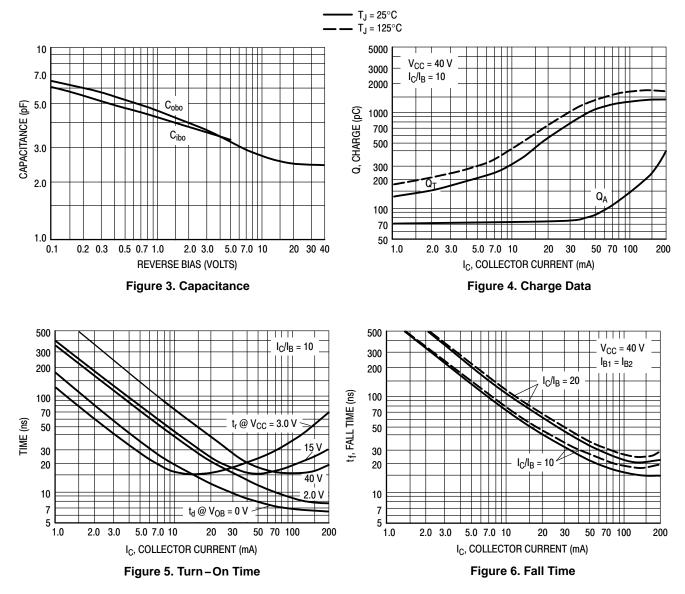


\* Total shunt capacitance of test jig and connectors

Figure 1. Delay and Rise Time Equivalent Test Circuit

Figure 2. Storage and Fall Time Equivalent Test Circuit

# **TYPICAL TRANSIENT CHARACTERISTICS**



### TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE VARIATIONS

 $(V_{CE} = -5.0 \text{ Vdc}, T_A = 25^{\circ}\text{C}, \text{ Bandwidth} = 1.0 \text{ Hz})$ 

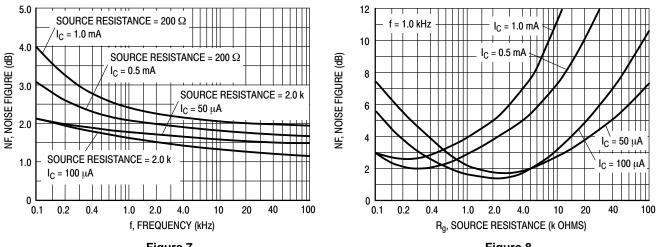
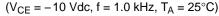
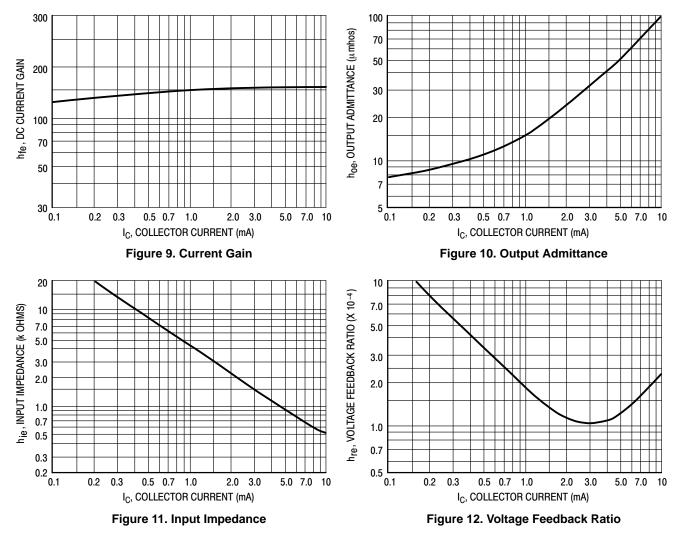


Figure 7.

Figure 8.





# **TYPICAL STATIC CHARACTERISTICS**

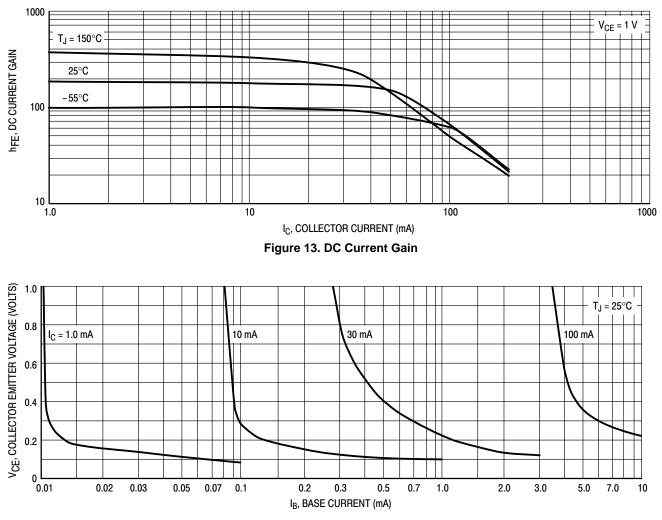
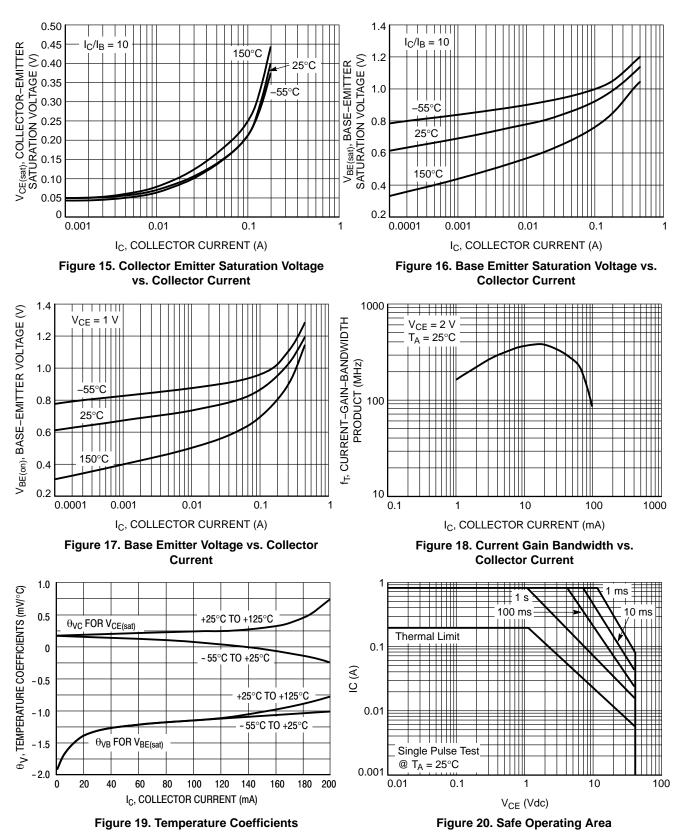


Figure 14. Collector Saturation Region







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